

N-Channel Enhancement Mode Power MOSFET

Description

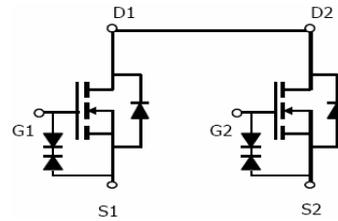
The PE6968E uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications .It is ESD protested.

General Features

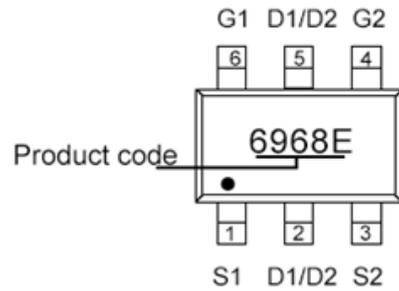
- $V_{DS} = 20V, I_D = 6A$
- $R_{DS(ON)} < 24m\Omega @ V_{GS}=2.5V$
- $R_{DS(ON)} < 18m\Omega @ V_{GS}=4.5V$
- ESD Rating: 2000V HBM
- High power and current handing capability
- Lead free product is acquired
- Surface mount package

Application

- PWM application
- Load switch



Schematic diagram



Marking and pin Assignment



SOT23-6 top view

Absolute Maximum Ratings ($T_A=25^{\circ}C$ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|----------------|------------|-------------|
| Drain-Source Voltage | V_{DS} | 20 | V |
| Gate-Source Voltage | V_{GS} | ± 10 | V |
| Drain Current-Continuous | I_D | 6 | A |
| Drain Current-Pulsed ^(Note 1) | I_{DM} | 30 | A |
| Maximum Power Dissipation | P_D | 1.5 | W |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 To 150 | $^{\circ}C$ |

Thermal Characteristic

| | | | |
|---|-----------------|------|---------------|
| Thermal Resistance, Junction-to-Ambient ^(Note 2) | $R_{\theta JA}$ | 83.3 | $^{\circ}C/W$ |
|---|-----------------|------|---------------|

Electrical Characteristics ($T_A=25^{\circ}C$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|---------------------------------|------------|---------------------------|-----|-----|-----|---------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 20 | | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=20V, V_{GS}=0V$ | - | - | 1 | μA |

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|--|--------------|---|------|------|----------|------------|
| Gate-Body Leakage Current | I_{GSS} | $V_{GS}=\pm 10V, V_{DS}=0V$ | - | - | ± 10 | μA |
| On Characteristics ^(Note 3) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | 0.55 | 0.8 | 1.0 | V |
| Drain-Source On-State Resistance | $R_{DS(on)}$ | $V_{GS}=4.5V, I_D=6A$ | 13 | 15.5 | 18 | m Ω |
| | | $V_{GS}=3.8V, I_D=5.5A$ | 14 | 16.5 | 19 | m Ω |
| | | $V_{GS}=2.5V, I_D=5A$ | 18 | 21 | 24 | m Ω |
| Forward Transconductance | g_{FS} | $V_{DS}=5V, I_D=6A$ | - | 20 | - | S |
| Dynamic Characteristics ^(Note4) | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS}=10V, V_{GS}=0V,$ $F=1.0MHz$ | - | 650 | - | PF |
| Output Capacitance | C_{oss} | | - | 140 | - | PF |
| Reverse Transfer Capacitance | C_{rss} | | - | 60 | - | PF |
| Switching Characteristics ^(Note 4) | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD}=10V, R_L=1.5\Omega$ $V_{GS}=5V, R_{GEN}=3\Omega$ | - | 0.5 | | nS |
| Turn-on Rise Time | t_r | | - | 1 | | nS |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 12 | | nS |
| Turn-Off Fall Time | t_f | | - | 4 | | nS |
| Total Gate Charge | Q_g | $V_{DS}=10V, I_D=6A,$ $V_{GS}=4.5V$ | - | 8 | | nC |
| Gate-Source Charge | Q_{gs} | | - | 2.5 | - | nC |
| Gate-Drain Charge | Q_{gd} | | - | 3 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage ^(Note 3) | V_{SD} | $V_{GS}=0V, I_S=1A$ | - | - | 1.2 | V |
| Diode Forward Current ^(Note 2) | I_S | | - | - | 6 | A |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production

Typical Electrical and Thermal Characteristics

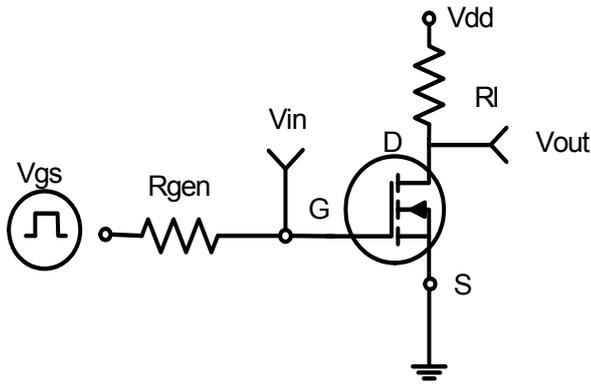


Figure 1: Switching Test Circuit

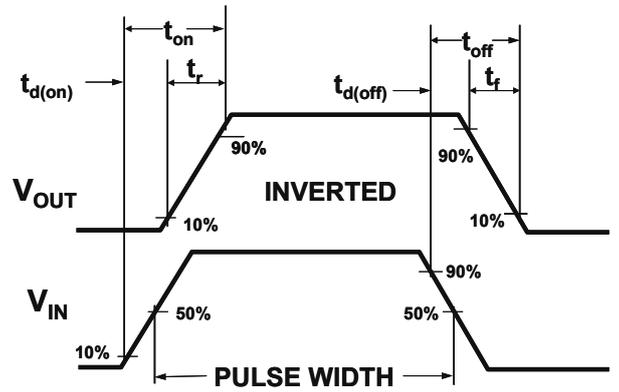


Figure 2: Switching Waveforms

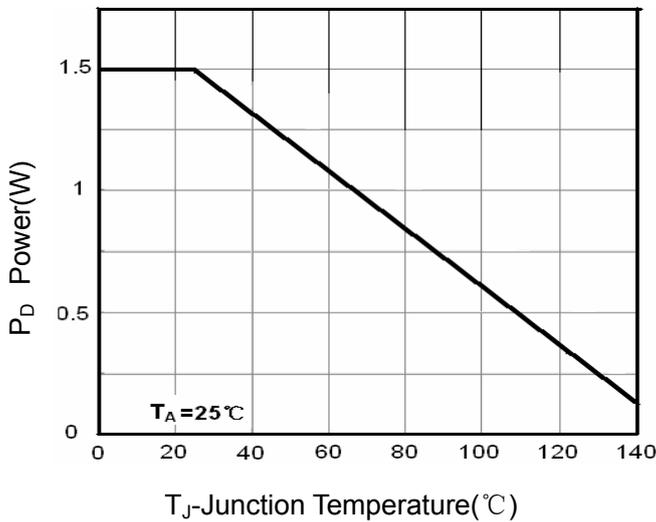


Figure 3 Power Dissipation

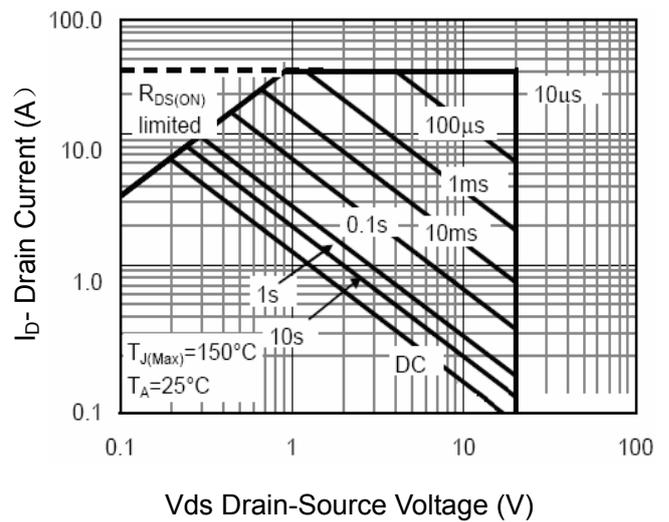


Figure 4 Safe Operation Area

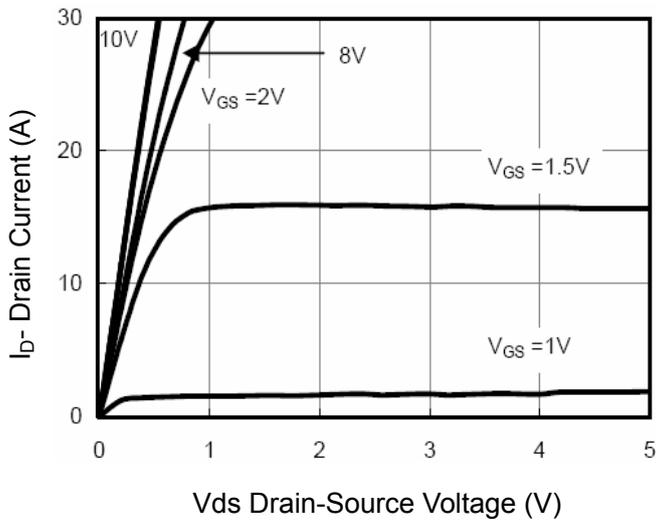


Figure 5 Output Characteristics

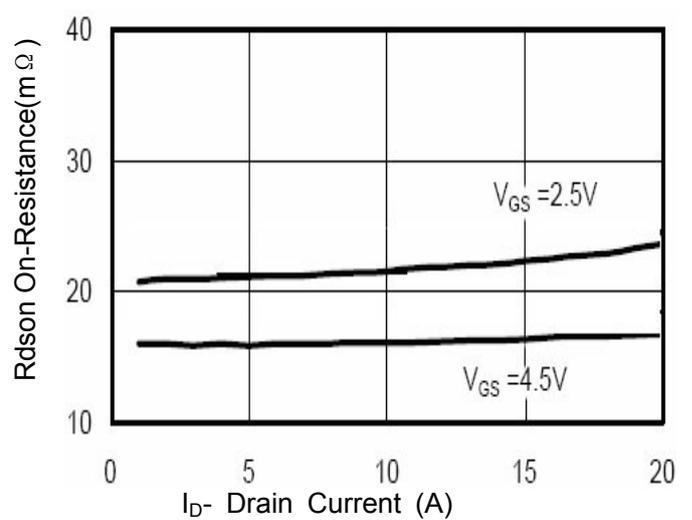


Figure 6 Drain-Source On-Resistance

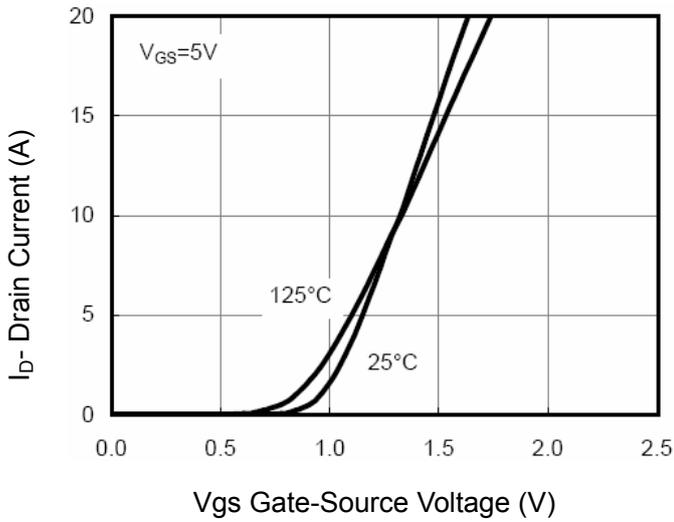


Figure 7 Transfer Characteristics

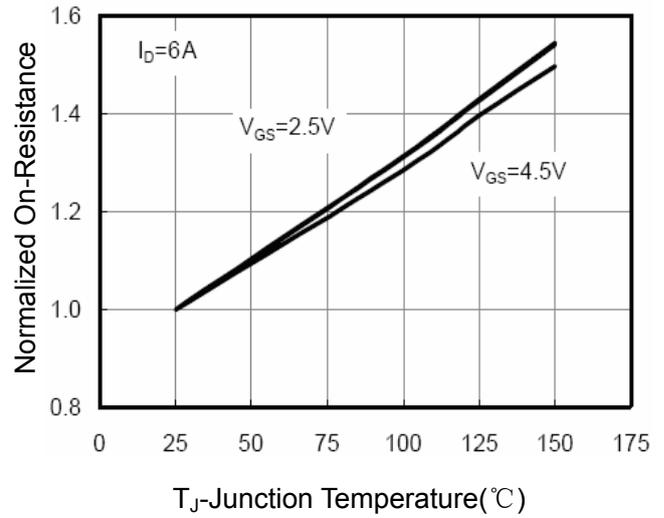


Figure 8 Drain-Source On-Resistance

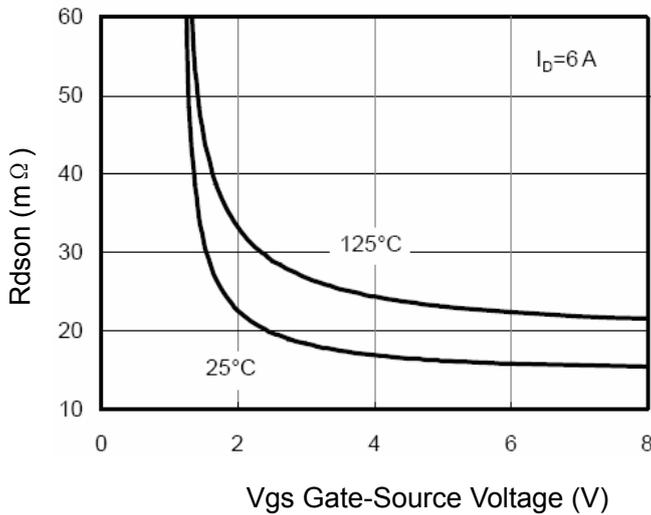


Figure 9 Rdson vs VGS

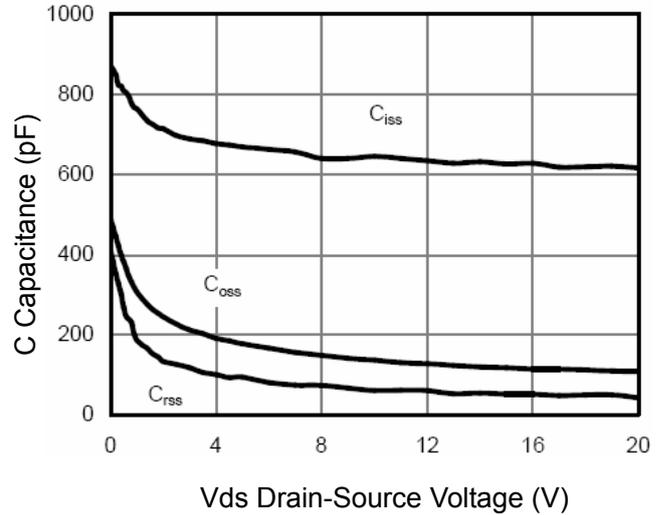


Figure 10 Capacitance vs Vds

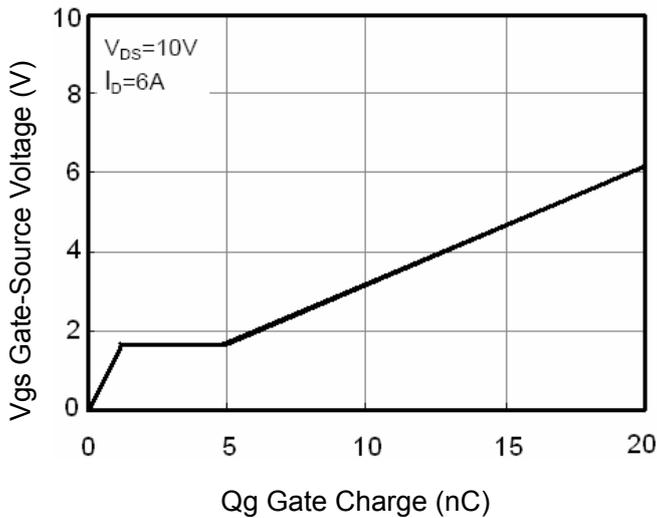


Figure 11 Gate Charge

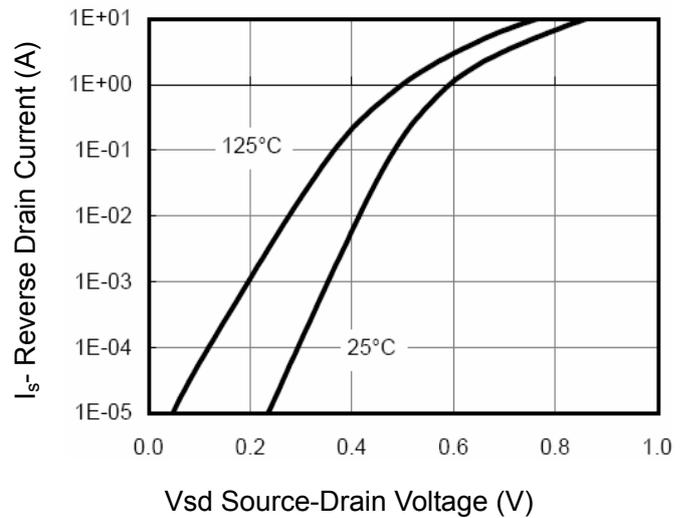


Figure 12 Source- Drain Diode Forward

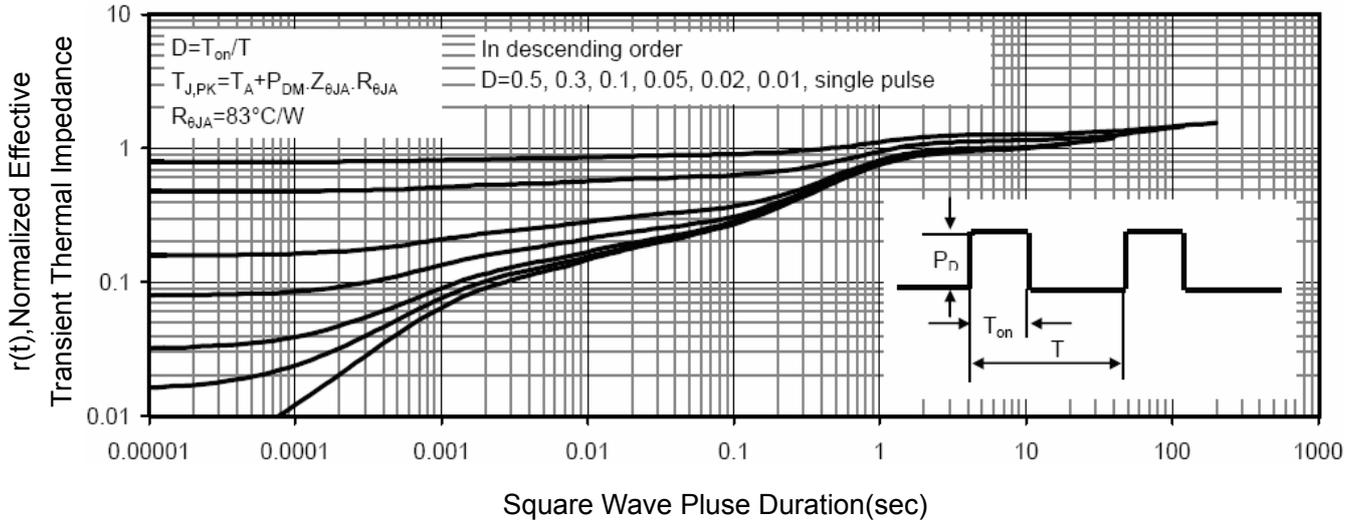


Figure 13 Normalized Maximum Transient Thermal Impedance

SOT23-6 PACKAGE INFORMATION

